

2SK2645-01MR

FAP-IIS Series

N-channel MOS-FET					
600V	$1,2\Omega$	9A	50W		

> Features

- High Speed Switching
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- Vgs = ± 30V Guarantee
- Repetitive Avalanche Rated

> Applications

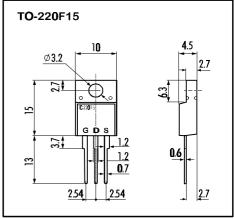
- Switching Regulators
- UPS
- DC-DC converters
- General Purpose Power Amplifier

> Maximum Ratings and Characteristics

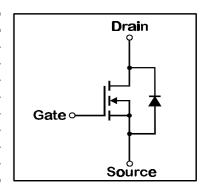
Absolute Maximum RatingsT(C=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V _{DS}	600	V
Continous Drain Current	ΙD	9	Α
Pulsed Drain Current	I _{D(puls)}	32	Α
Gate-Source-Voltage	V _{GS}	±30	V
Repetitive or Non-Repetitive (T _{ch} ≤ 150°C)	I _{AR}	9	Α
Avalanche Energy	E AS	71,9	mJ
Max. Power Dissipation	P _D	50	W
Operating and Storage Temperature Range	T ch	150	°C
	T _{stg}	-55 ~ +150	°C

> Outline Drawing



> Equivalent Circuit



- Electrical Characteristics (T_C=25°C), unless otherwise specified

Item	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown-Voltage	V (BR)DSS	I_D =1mA V_{GS} =0V	600			V
Gate Threshhold Voltage	V _{GS(th)}	I_D =1mA $V_{DS}=V_{GS}$	3,5	4,0	4,5	V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =600V T_{ch} =25°C		10	500	μA
		$V_{GS}=0V$ $T_{ch}=125^{\circ}C$		0,2	1,0	mA
Gate Source Leakage Current	I _{GSS}	V_{GS} =±30V V_{DS} =0V		10	100	nA
Drain Source On-State Resistance	R _{DS(on)}	I _D =4A V _{GS} =10V		1,0	1,2	Ω
Forward Transconductance	g fs	$I_D=4A$ $V_{DS}=25V$	2,5	5		S
Input Capacitance	C iss	V _{DS} =25V		900	1400	pF
Output Capacitance	C oss	V_{GS} =0 V		150	230	рF
Reverse Transfer Capacitance	C rss	f=1MHz		70	110	pF
Turn-On-Time t _{on} (t _{on} =t _{d(on)} +t _r)	t _{d(on)}	V _{CC} =300V		25	40	ns
	t r	I _D =9A		70	110	ns
Turn-Off-Time $t_{off}(t_{on}=t_{d(off)}+t_f)$	t _{d(off)}	V _{GS} =10V		60	90	ns
	t f	R_{GS} =10 Ω		35	60	ns
Avalanche Capability	I _{AV}	$L = 100 \mu H$ $T_{ch} = 25 ^{\circ} C$	9			Α
Diode Forward On-Voltage	V _{SD}	$I_F=2xI_{DR}$ $V_{GS}=0V$ $T_{ch}=25^{\circ}C$	С	1,0	1,5	V
Reverse Recovery Time	t _{rr}	I _F =I _{DR} V _{GS} =0V		550		ns
Reverse Recovery Charge	Qπ	-dI _F /dt=100A/ μ s T _{ch} =25°C)	7,0	_	μC

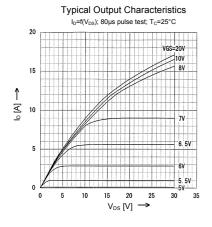
- Thermal Characteristics

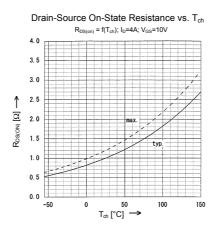
Item	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance	R _{th(ch-a)}	channel to air			62,5	°C/W
	R th(ch-c)	channel to case			2,5	°C/W

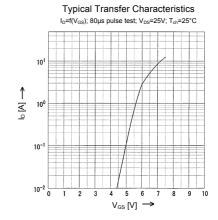
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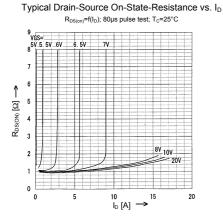
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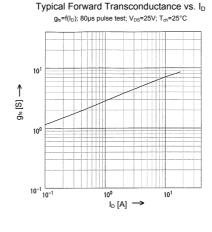
> Characteristics

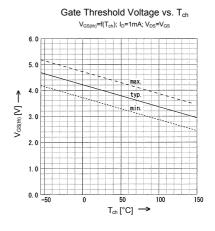


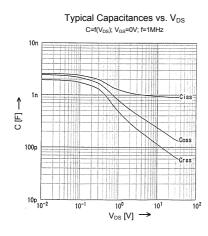


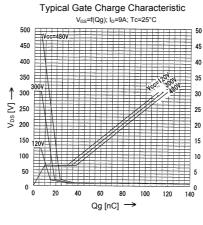












V_{GS} [V] →

